IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: 2826 Examiner: Fazli Erdem

AMENDMENT

In re PATENT APPLICATION of

Applicants: Takahiro OKA et al.

Appl. No.: 09/912,064

Filed July 25, 2001

For SEMICONDUCTOR CHIP PACKAGE

Atty. Dkt.: **TAI 129**

December 2, 2002

Box Non-Fee Amendment

Commissioner of Patents Washington, D.C. 20231

Sir:

In response to a Notice of Allowance dated September 5, 2002, please enter this Amendment filed simultaneously with the RCE attached.

IN THE CLAIMS

Please cancel claim 2 and amend claims 1 3, 4, and 8 without prejudice or disclaimer, as follows:

1. (Amended) A semiconductor chip package comprising:

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